



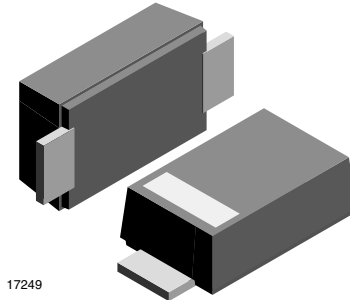
## Small Signal Fast Switching Diode, High Voltage

### Features

- For surface mounted applications
- Low profile package
- Ideal for automated placement
- Glass passivated
- High temperature soldering: 260 °C/10 s at terminals
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 available



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available



17249

### Mechanical Data

**Case:** JEDEC DO-219AB (SMF<sup>®</sup>) plastic case

**Polarity:** band denotes cathode end

**Weight:** approx. 15 mg

### Ordering Information/Packaging Codes

S07B-GSxx

GS08 = 3K per 7" reel (8 mm tape)  
GS18 = 10K per 13" reel (8 mm tape)  
Part number

S07B-M-xx

08 = 3K per 7" reel (8 mm tape)  
18 = 10K per 13" reel (8 mm tape)  
Environmental suffix -M- defines halogen-free  
Part number

### Parts Table

Part	Ordering code	Marking	Remarks
S07B	S07B-GS18 or S07B-GS08	SB	Tape and reel
S07D	S07D-GS18 or S07D-GS08	SD	Tape and reel
S07G	S07G-GS18 or S07G-GS08	SG	Tape and reel
S07J	S07J-GS18 or S07J-GS08	SJ	Tape and reel
S07M	S07M-GS18 or S07M-GS08	SM	Tape and reel

## Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Maximum repetitive peak reverse voltage		S07B	$V_{RRM}$	100	V
		S07D	$V_{RRM}$	200	V
		S07G	$V_{RRM}$	400	V
		S07J	$V_{RRM}$	600	V
		S07M	$V_{RRM}$	1000	V
Maximum RMS voltage		S07B	$V_{RMS}$	70	V
		S07D	$V_{RMS}$	140	V
		S07G	$V_{RMS}$	280	V
		S07J	$V_{RMS}$	420	V
		S07M	$V_{RMS}$	700	V
Maximum DC blocking voltage		S07B	$V_{DC}$	100	V
		S07D	$V_{DC}$	200	V
		S07G	$V_{DC}$	400	V
		S07J	$V_{DC}$	600	V
		S07M	$V_{DC}$	1000	V
Maximum average forward rectified current	$T_{tp} = 75\text{ }^{\circ}\text{C}^{1)}$		$I_{F(AV)}$	1.5	A
	$T_A = 65\text{ }^{\circ}\text{C}^{1)}$		$I_{F(AV)}$	0.7	A
Peak forward surge current 8.3 ms single half sine-wave	$T_L = 25\text{ }^{\circ}\text{C}$		$I_{FSM}$	25	A

Note:

<sup>1)</sup> Averaged over any 20 ms period

## Thermal Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air <sup>1)</sup>		$R_{thJA}$	180	K/W
Operating junction and storage temperature range		$T_J, T_{STG}$	- 55 to + 150	$^{\circ}\text{C}$

Note:

<sup>1)</sup> Mounted on epoxy substrate with 3 mm x 3 mm CU pads ( $\geq 40$  mm thick)

## Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Min.	Typ.	Max.	Unit
Maximum instantaneous forward voltage	1.0 A <sup>1)</sup>	$V_F$			1.1	V
Maximum DC reverse current at rated DC blocking voltage	$T_A = 25\text{ }^{\circ}\text{C}$	$I_R$			10	$\mu\text{A}$
	$T_A = 125\text{ }^{\circ}\text{C}$	$I_R$			50	$\mu\text{A}$
Reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$	$t_{rr}$			1.8	$\mu\text{s}$
Typical capacitance at 4 V, MHz		$C_j$		4		pF

Note:

<sup>1)</sup> Pulse test: 300  $\mu$  pulse width, 1 % duty cycle

## Typical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

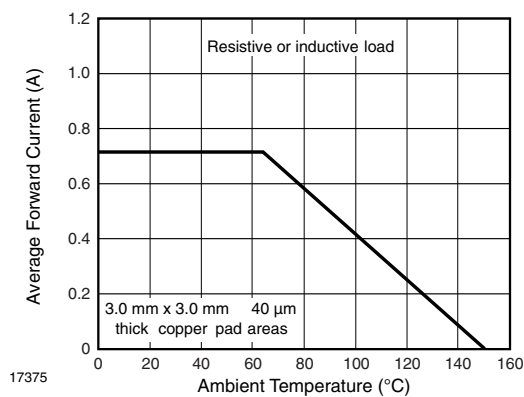


Figure 1. Forward Current Derating Curve

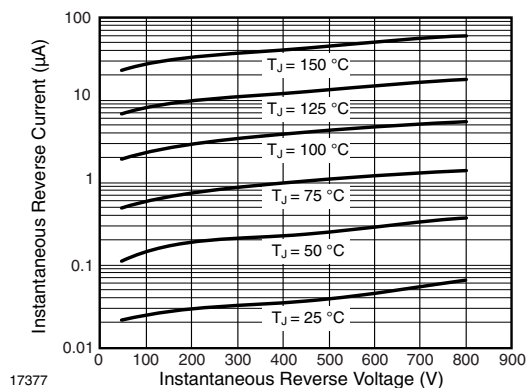


Figure 3. Typical Instantaneous Reverse Characteristics

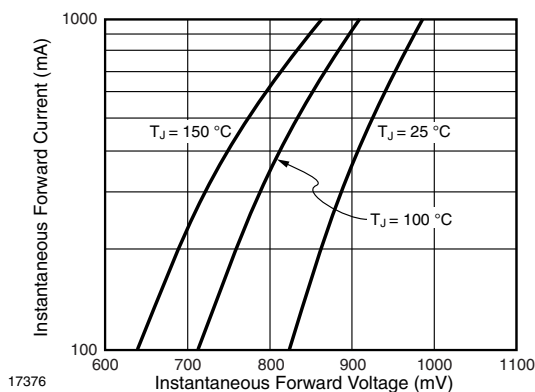


Figure 2. Typical Instantaneous Forward Characteristics

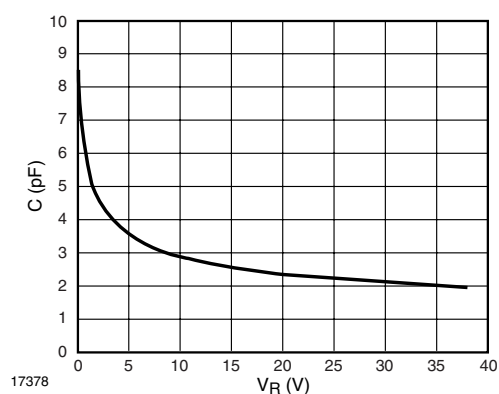
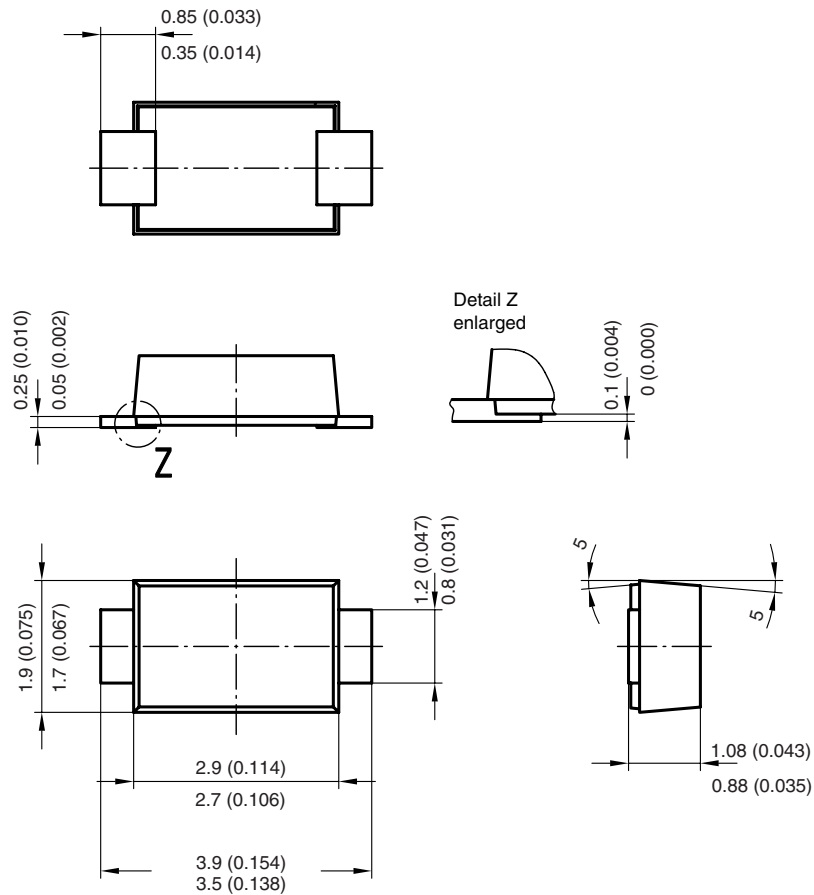
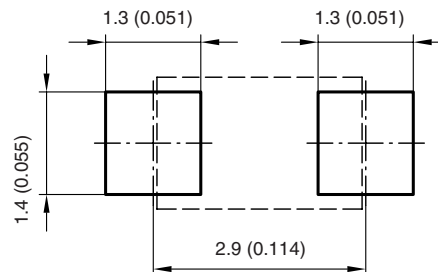


Figure 4. Capacitance vs. Reverse Voltage

## Package Dimensions in millimeters (inches)



Foot print recommendation:



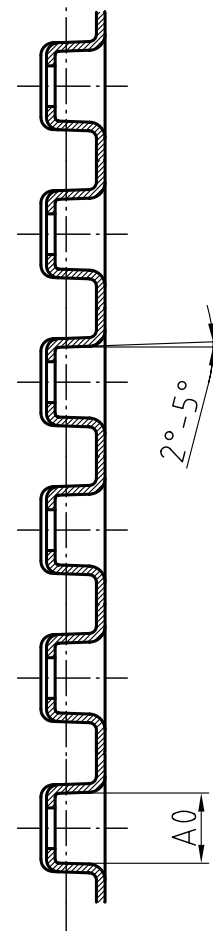
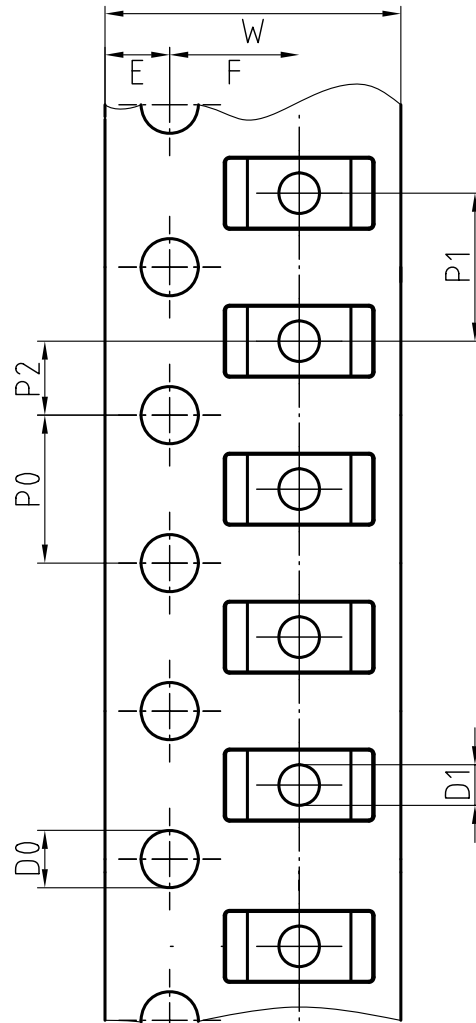
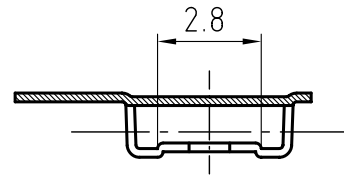
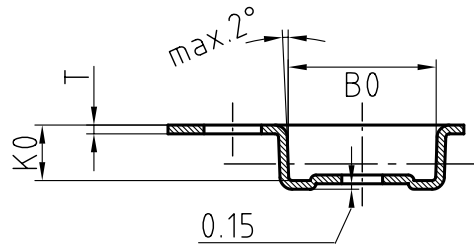
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 17247



# S070B, S07D, S07G, S07J, S07M

Vishay Semiconductors

## Blisertape for SMF



Mat:	A0	B0	K0	W	T	P0	P2	P1	D0	D1	E	F
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### Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design  
and may do so without further notice.

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Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



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